

SN74LVC245A OCTAL BUS TRANSCEIVER WITH 3-STATE OUTPUTS

SCAS218T – JANUARY 1993 – REVISED JULY 2004

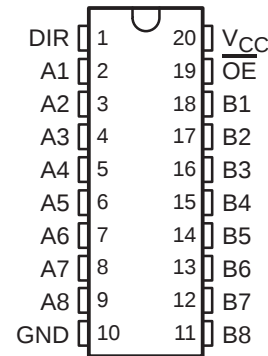
- Operates From 1.65 V to 3.6 V
- Inputs Accept Voltages to 5.5 V
- Max t_{pd} of 6.3 ns at 3.3 V
- Typical V_{OLP} (Output Ground Bounce)
 <0.8 V at $V_{CC} = 3.3$ V, $T_A = 25^\circ\text{C}$
- Typical V_{OHV} (Output V_{OH} Undershoot)
 >2 V at $V_{CC} = 3.3$ V, $T_A = 25^\circ\text{C}$
- I_{off} Supports Partial-Power-Down Mode Operation
- Supports Mixed-Mode Signal Operation on All Ports (5-V Input/Output Voltage With 3.3-V V_{CC})
- Latch-Up Performance Exceeds 250 mA Per JESD 17
- ESD Protection Exceeds JESD 22
 - 2000-V Human-Body Model (A114-A)
 - 1000-V Charged-Device Model (C101)

description/ordering information

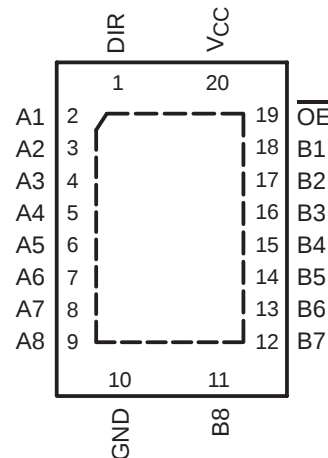
This octal bus transceiver is designed for 1.65-V to 3.6-V V_{CC} operation.

The SN74LVC245A is designed for asynchronous communication between data buses. The device transmits data from the A bus to the B bus or from the B bus to the A bus, depending on the logic level at the direction-control (DIR) input. The output-enable ($\overline{OE}$) input can be used to disable the device so the buses are effectively isolated.

DB, DGV, DW, N, NS, OR PW PACKAGE
(TOP VIEW)



RGY PACKAGE
(TOP VIEW)



ORDERING INFORMATION

T_A	PACKAGE†		ORDERABLE PART NUMBER	TOP-SIDE MARKING
-40°C to 85°C	PDIP – N	Tube of 20	SN74LVC245AN	SN74LVC245AN
	QFN – RGY	Reel of 1000	SN74LVC245ARGYR	LC245A
	SOIC – DW	Tube of 25	SN74LVC245ADW	LVC245A
		Reel of 2000	SN74LVC245ADWR	
	SOP – NS	Reel of 2000	SN74LVC245ANSR	LVC245A
	SSOP – DB	Reel of 2000	SN74LVC245ADBR	LC245A
	TSSOP – PW	Tube of 70	SN74LVC245APW	LC245A
		Reel of 2000	SN74LVC245APWR	
		Reel of 250	SN74LVC245APWT	
	TVSOP – DGV	Reel of 2000	SN74LVC245ADGVR	LC245A
	VFBGA – GQN	Reel of 1000	SN74LVC245AGQNR	LC245A
	VFBGA – ZQN (Pb-Free)		SN74LVC245AZQNR	

† Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

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PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

**TEXAS
INSTRUMENTS**

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SN74LVC245A

OCTAL BUS TRANSCEIVER

WITH 3-STATE OUTPUTS

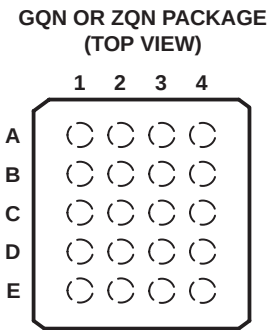
SCAS218T – JANUARY 1993 – REVISED JULY 2004

description/ordering information (continued)

To ensure the high-impedance state during power up or power down, $\overline{OE}$ should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

Inputs can be driven from either 3.3-V or 5-V devices. This feature allows the use of this device as a translator in a mixed 3.3-V/5-V system environment.

This device is fully specified for partial-power-down applications using I_{off} . The I_{off} circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.



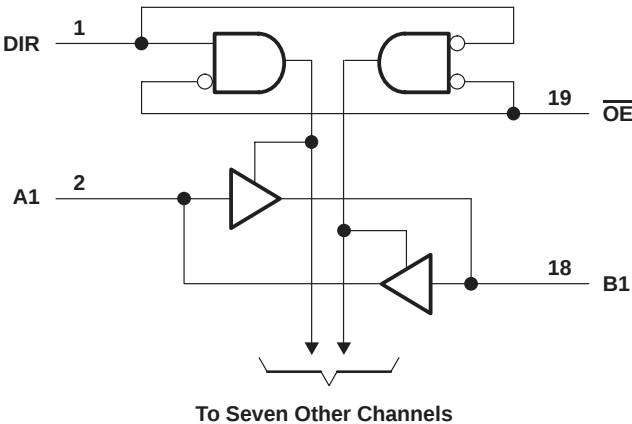
terminal assignments

	1	2	3	4
A	A1	DIR	V_{CC}	$\overline{OE}$
B	A3	B2	A2	B1
C	A5	A4	B4	B3
D	A7	B6	A6	B5
E	GND	A8	B8	B7

FUNCTION TABLE

INPUTS		OPERATION
$\overline{OE}$	DIR	
L	L	B data to A bus
L	H	A data to B bus
H	X	Isolation

logic diagram (positive logic)



Pin numbers shown are for the DB, DGV, DW, N, NS, PW, and RGY packages.

SN74LVC245A OCTAL BUS TRANSCEIVER WITH 3-STATE OUTPUTS

SCAS218T – JANUARY 1993 – REVISED JULY 2004

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage range, V_{CC}	–0.5 V to 6.5 V
Input voltage range, V_I (see Note 1)	–0.5 V to 6.5 V
Voltage range applied to any output in the high-impedance or power-off state, V_O (see Note 1)	–0.5 V to 6.5 V
Voltage range applied to any output in the high or low state, V_O (see Notes 1 and 2)	–0.5 V to $V_{CC} + 0.5$ V
Input clamp current, I_{IK} ($V_I < 0$)	–50 mA
Output clamp current, I_{OK} ($V_O < 0$)	–50 mA
Continuous output current, I_O	±50 mA
Continuous current through V_{CC} or GND	±100 mA
Package thermal impedance, θ_{JA} (see Note 3): DB package	70°C/W
(see Note 3): DGV package	92°C/W
(see Note 3): DW package	58°C/W
(see Note 3): GQN/ZQN package	78°C/W
(see Note 3): N package	69°C/W
(see Note 3): NS package	60°C/W
(see Note 3): PW package	83°C/W
(see Note 4): RGY package	37°C/W
Storage temperature range, T_{stg}	–65°C to 150°C

[†] Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES:
1. The input and output negative-voltage ratings may be exceeded if the input and output current ratings are observed.
 2. The value of V_{CC} is provided in the recommended operating conditions table.
 3. The package thermal impedance is calculated in accordance with JESD 51-7.
 4. The package thermal impedance is calculated in accordance with JESD 51-5.



SN74LVC245A

OCTAL BUS TRANSCEIVER

WITH 3-STATE OUTPUTS

SCAS218T – JANUARY 1993 – REVISED JULY 2004

recommended operating conditions (see Note 5)

			T _A = 25°C		−40°C TO 85°C		UNIT
			MIN	MAX	MIN	MAX	
V _{CC}	Supply voltage	Operating	1.65	3.6	1.65	3.6	V
		Data retention only	1.5		1.5		
V _{IH}	High-level input voltage	V _{CC} = 1.65 V to 1.95 V	0.65 × V _{CC}		0.65 × V _{CC}		V
		V _{CC} = 2.3 V to 2.7 V	1.7		1.7		
		V _{CC} = 2.7 V to 3.6 V	2		2		
V _{IL}	Low-level input voltage	V _{CC} = 1.65 V to 1.95 V	0.35 × V _{CC}		0.35 × V _{CC}		V
		V _{CC} = 2.3 V to 2.7 V	0.7		0.7		
		V _{CC} = 2.7 V to 3.6 V	0.8		0.8		
V _I	Input voltage		0	5.5	0	5.5	V
V _O	Output voltage		0	V _{CC}	0	V _{CC}	V
I _{OH}	High-level output current	V _{CC} = 1.65 V	−4		−4		mA
		V _{CC} = 2.3 V	−8		−8		
		V _{CC} = 2.7 V	−12		−12		
		V _{CC} = 3 V	−24		−24		
I _{OL}	Low-level output current	V _{CC} = 1.65 V	4		4		mA
		V _{CC} = 2.3 V	8		8		
		V _{CC} = 2.7 V	12		12		
		V _{CC} = 3 V	24		24		
Δt/Δv	Input transition rise or fall rate		10		10		ns/V

NOTE 5: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

SN74LVC245A

OCTAL BUS TRANSCEIVER

WITH 3-STATE OUTPUTS

SCAS218T – JANUARY 1993 – REVISED JULY 2004

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS	V _{CC}	T _A = 25°C			–40°C TO 85°C		UNIT
				MIN	TYP	MAX	MIN	MAX	
V _{OH}		I _{OH} = –100 μA	1.65 V to 3.6 V	V _{CC} – 0.2			V _{CC} – 0.2		V
		I _{OH} = –4 mA	1.65 V	1.29			1.2		
		I _{OH} = –8 mA	2.3 V	1.9			1.7		
		I _{OH} = –12 mA	2.7 V	2.2			2.2		
			3 V	2.4			2.4		
		I _{OH} = –24 mA	3 V	2.3			2.2		
V _{OL}		I _{OL} = 100 μA	1.65 V to 3.6 V	0.1			0.2		V
		I _{OL} = 4 mA	1.65 V	0.24			0.45		
		I _{OL} = 8 mA	2.3 V	0.3			0.7		
		I _{OL} = 12 mA	2.7 V	0.4			0.4		
		I _{OL} = 24 mA	3 V	0.55			0.55		
I _I	Control inputs	V _I = 0 to 5.5 V	3.6 V	±1			±5		μA
I _{off}		V _I or V _O = 5.5 V	0	±1			±10		μA
I _{OZ} [†]		V _O = 0 to 5.5 V	3.6 V	±1			±10		μA
I _{CC}		V _I = V _{CC} or GND	3.6 V	1			10		μA
		3.6 V ≤ V _I ≤ 5.5 V [‡]		1			10		
ΔI _{CC}		One input at V _{CC} – 0.6 V, Other inputs at V _{CC} or GND	2.7 V to 3.6 V	500			500		μA
C _i	Control inputs	V _I = V _{CC} or GND	3.3 V	4					pF
C _{io}	A or B ports	V _I = V _{CC} or GND	3.3 V	5.5					pF

[†] For I/O ports, the parameter I_{OZ} includes the input leakage current.

[‡] This applies in the disabled state only.

switching characteristics over recommended operating free-air temperature range (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V _{CC}	T _A = 25°C			–40°C TO 85°C		UNIT
				MIN	TYP	MAX	MIN	MAX	
t _{pd}	A or B	B or A	1.8 V ± 0.15 V	1	6	12.2	1	12.7	ns
			2.5 V ± 0.2 V	1	3.9	7.8	1	8.3	
			2.7 V	1	4.2	7.1	1	7.3	
			3.3 V ± 0.3 V	1.5	3.8	6.1	1.5	6.3	
t _{en}	$\overline{\text{OE}}$	A or B	1.8 V ± 0.15 V	1	7	14.8	1	15.3	ns
			2.5 V ± 0.2 V	1	4.5	10	1	10.5	
			2.7 V	1	5.4	9.3	1	9.5	
			3.3 V ± 0.3 V	1.5	4.4	8.3	1.5	8.5	
t _{dis}	$\overline{\text{OE}}$	A or B	1.8 V ± 0.15 V	1	7.8	16.5	1	17	ns
			2.5 V ± 0.2 V	1	4	9	1	9.5	
			2.7 V	1	4.4	8.3	1	8.5	
			3.3 V ± 0.3 V	1.7	4.1	7.3	1.7	7.5	
t _{sk(o)}			3.3 V ± 0.3 V				1		ns



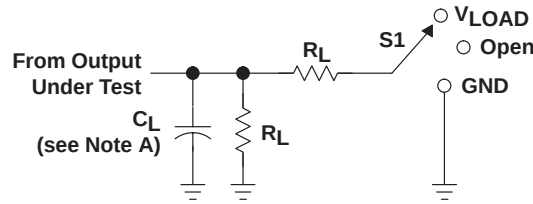
SN74LVC245A
OCTAL BUS TRANSCEIVER
WITH 3-STATE OUTPUTS

SCAS218T – JANUARY 1993 – REVISED JULY 2004

operating characteristics, $T_A = 25^{\circ}\text{C}$

PARAMETER		TEST CONDITIONS	V _{CC}	TYP	UNIT
C _{pd} Power dissipation capacitance per transceiver	Outputs enabled	f = 10 MHz	1.8 V	42	pF
			2.5 V	43	
			3.3 V	45	
	Outputs disabled		1.8 V	1	
			2.5 V	1	
			3.3 V	2	

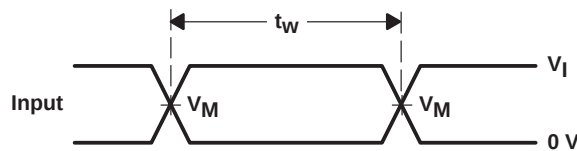
PARAMETER MEASUREMENT INFORMATION



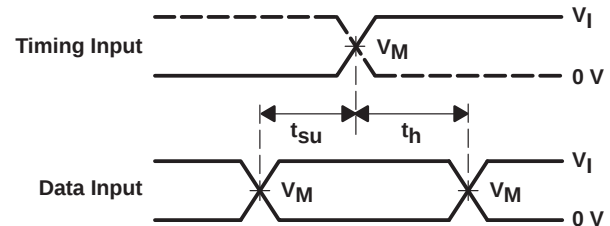
LOAD CIRCUIT

TEST	S1
t_{PLH}/t_{PHL}	Open
t_{PLZ}/t_{PZL}	V_{LOAD}
t_{PHZ}/t_{PZH}	GND

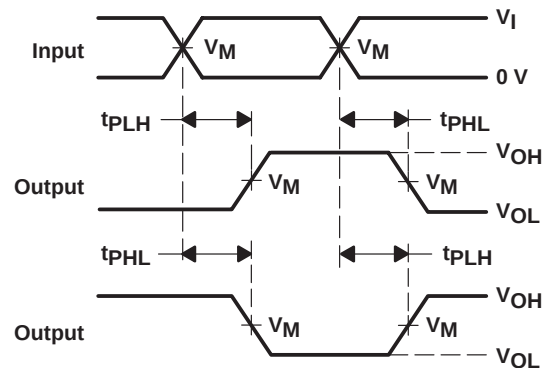
V_{CC}	INPUTS		V_M	V_{LOAD}	C_L	R_L	V_{Δ}
	V_I	t_r/t_f					
$1.8\text{ V} \pm 0.15\text{ V}$	V_{CC}	$\leq 2\text{ ns}$	$V_{CC}/2$	$2 \times V_{CC}$	30 pF	1 k Ω	0.15 V
$2.5\text{ V} \pm 0.2\text{ V}$	V_{CC}	$\leq 2\text{ ns}$	$V_{CC}/2$	$2 \times V_{CC}$	30 pF	500 Ω	0.15 V
2.7 V	2.7 V	$\leq 2.5\text{ ns}$	1.5 V	6 V	50 pF	500 Ω	0.3 V
$3.3\text{ V} \pm 0.3\text{ V}$	2.7 V	$\leq 2.5\text{ ns}$	1.5 V	6 V	50 pF	500 Ω	0.3 V



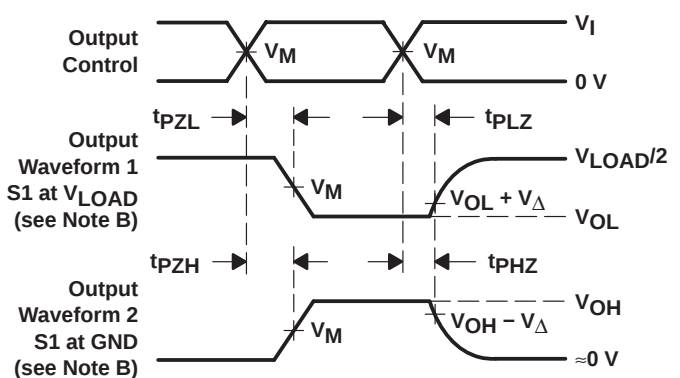
VOLTAGE WAVEFORMS
PULSE DURATION



VOLTAGE WAVEFORMS
SETUP AND HOLD TIMES



VOLTAGE WAVEFORMS
PROPAGATION DELAY TIMES
INVERTING AND NONINVERTING OUTPUTS



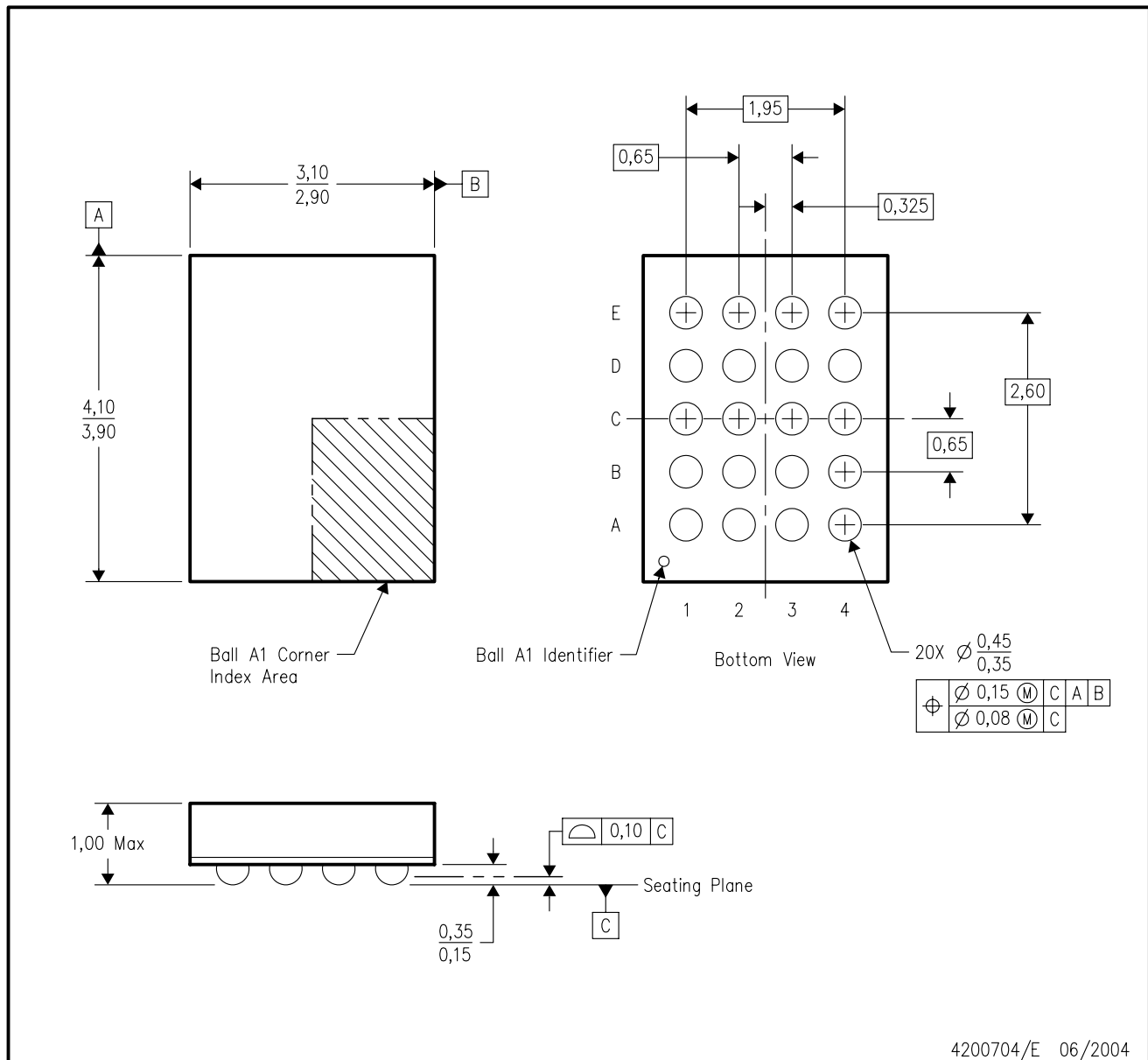
VOLTAGE WAVEFORMS
ENABLE AND DISABLE TIMES
LOW- AND HIGH-LEVEL ENABLING

- NOTES:
- A. C_L includes probe and jig capacitance.
 - B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
 - C. All input pulses are supplied by generators having the following characteristics: PRR $\leq 10\text{ MHz}$, $Z_O = 50\ \Omega$.
 - D. The outputs are measured one at a time, with one transition per measurement.
 - E. t_{PLZ} and t_{PHZ} are the same as t_{dis} .
 - F. t_{PZL} and t_{PZH} are the same as t_{en} .
 - G. t_{PLH} and t_{PHL} are the same as t_{pd} .
 - H. All parameters and waveforms are not applicable to all devices.

Figure 1. Load Circuit and Voltage Waveforms

GQN (R-PBGA-N20)

PLASTIC BALL GRID ARRAY

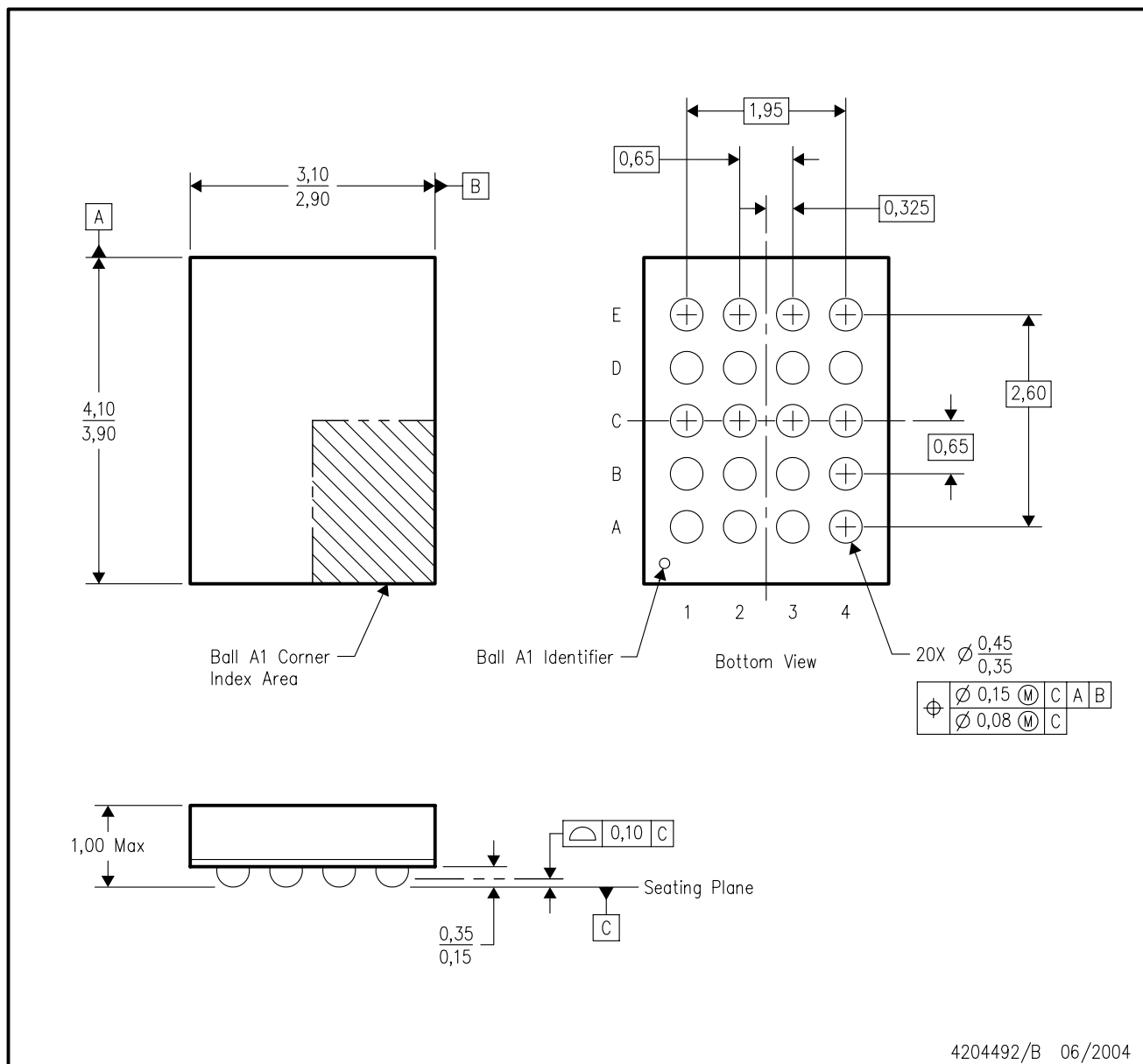


4200704/E 06/2004

- NOTES:
- All linear dimensions are in millimeters.
 - This drawing is subject to change without notice.
 - Falls within JEDEC MO-225 variation BC.
 - This package is tin-lead (SnPb). Refer to the 20 ZQN package (drawing 4204492) for lead-free.

ZQN (R-PBGA-N20)

PLASTIC BALL GRID ARRAY

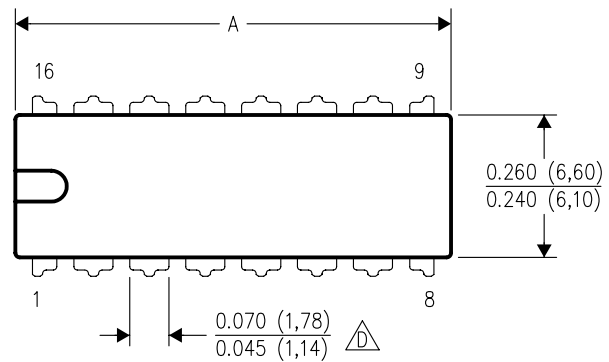


- NOTES:
- All linear dimensions are in millimeters.
 - This drawing is subject to change without notice.
 - Falls within JEDEC MO-225 variation BC.
 - This package is lead-free. Refer to the 20 GQN package (drawing 4200704) for tin-lead (SnPb).

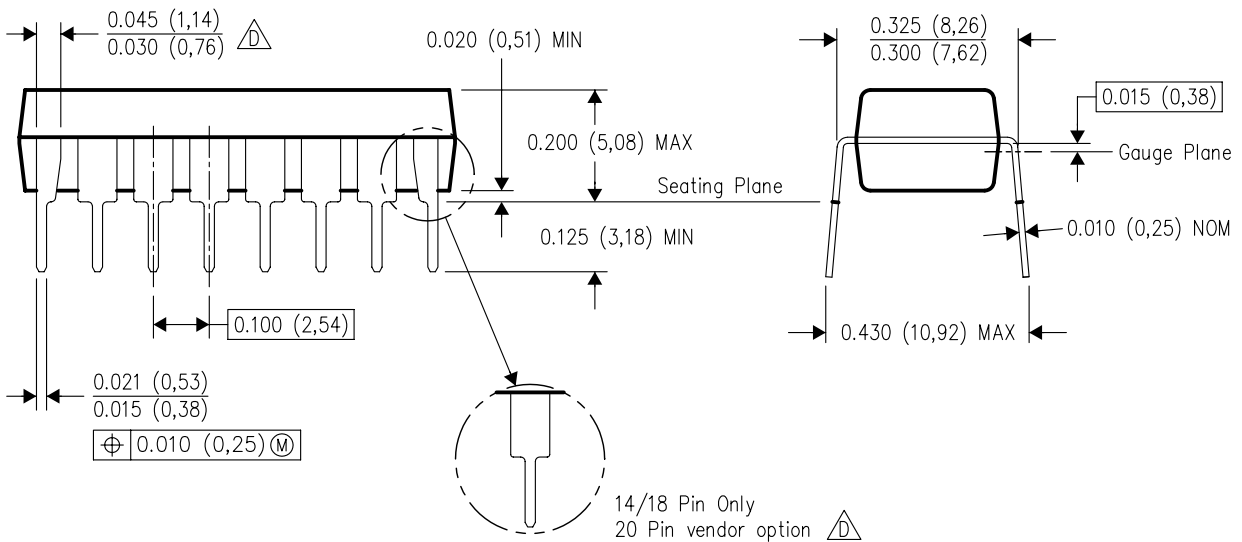
N (R-PDIP-T**)

16 PINS SHOWN

PLASTIC DUAL-IN-LINE PACKAGE



PINS **	14	16	18	20
DIM				
A MAX	0.775 (19,69)	0.775 (19,69)	0.920 (23,37)	1.060 (26,92)
A MIN	0.745 (18,92)	0.745 (18,92)	0.850 (21,59)	0.940 (23,88)
MS-001 VARIATION	AA	BB	AC	AD



14/18 Pin Only
20 Pin vendor option

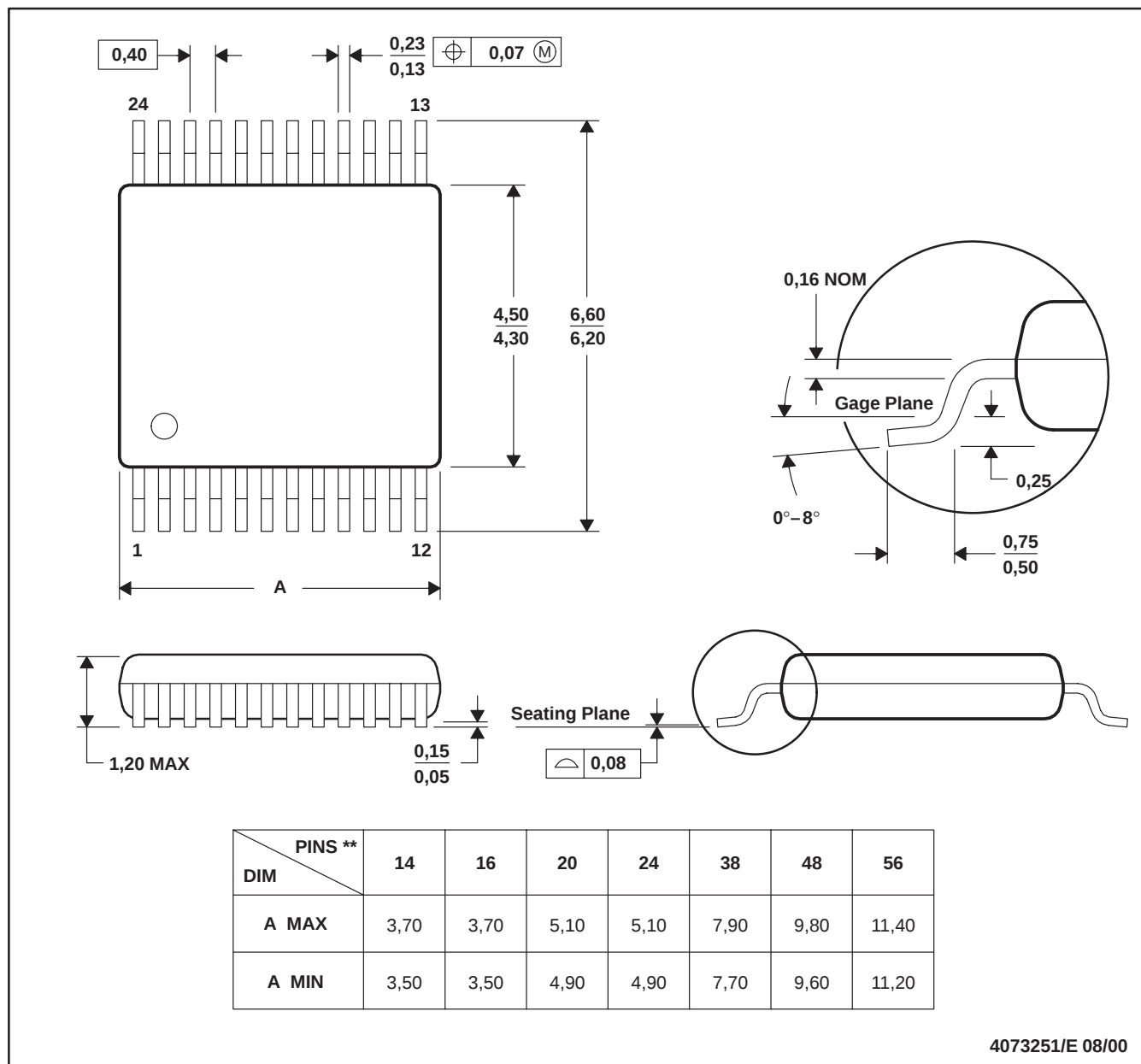
4040049/E 12/2002

- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
 - The 20 pin end lead shoulder width is a vendor option, either half or full width.

DGV (R-PDSO-G**)

PLASTIC SMALL-OUTLINE

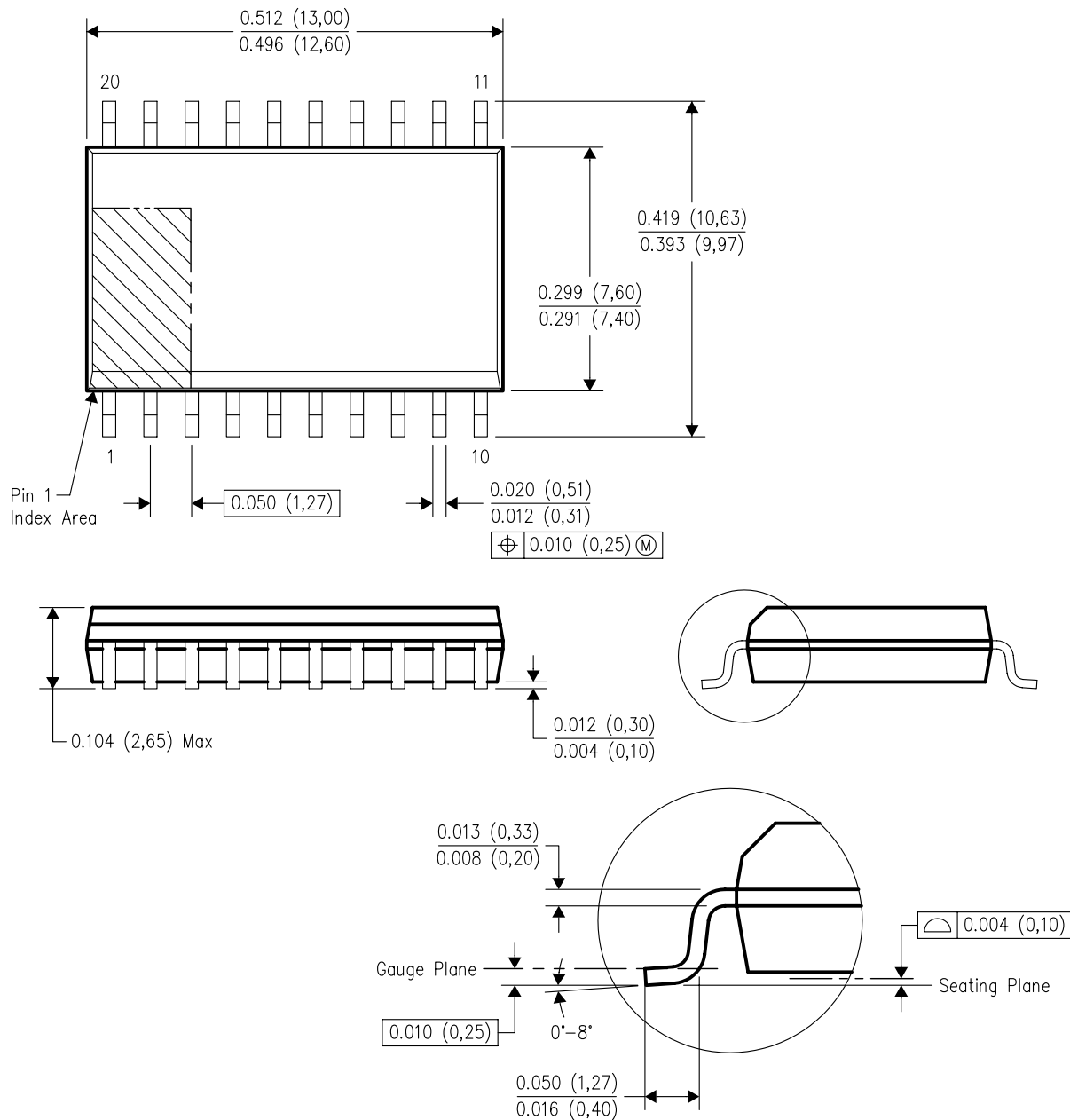
24 PINS SHOWN



- NOTES: A. All linear dimensions are in millimeters.
 B. This drawing is subject to change without notice.
 C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15 per side.
 D. Falls within JEDEC: 24/48 Pins – MO-153
 14/16/20/56 Pins – MO-194

DW (R-PDSO-G20)

PLASTIC SMALL-OUTLINE PACKAGE

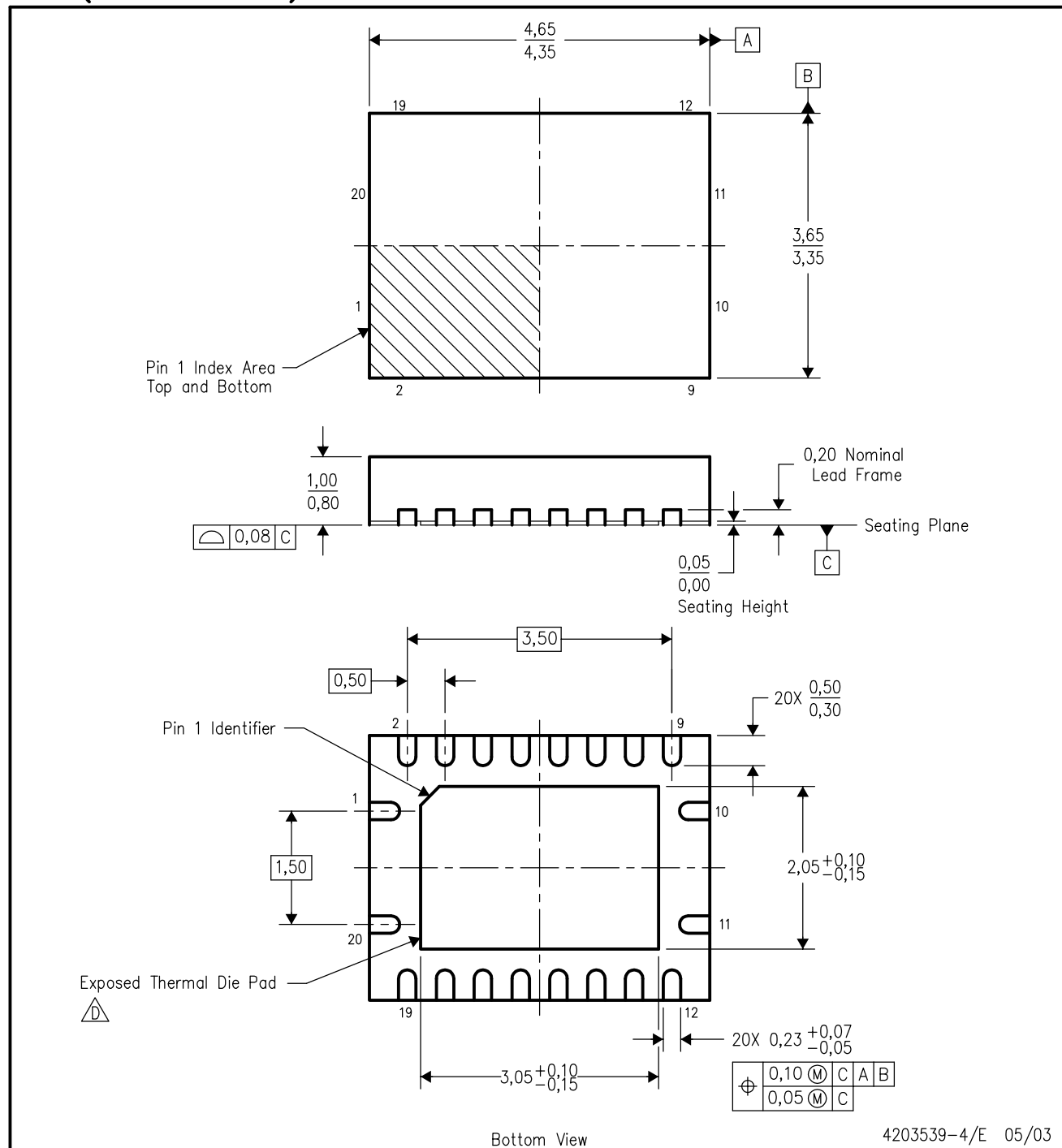


4040000-4/F 06/2004

- NOTES:
- All linear dimensions are in inches (millimeters).
 - This drawing is subject to change without notice.
 - Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
 - Falls within JEDEC MS-013 variation AC.

RGY (R-PQFP-N20)

PLASTIC QUAD FLATPACK



4203539-4/E 05/03

- NOTES:
- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. QFN (Quad Flatpack No-Lead) package configuration.
 - D. The package thermal performance may be enhanced by bonding the thermal die pad to an external thermal plane. This pad is electrically and thermally connected to the backside of the die and possibly selected ground leads.
 - E. Package complies to JEDEC MO-241 variation BC.

MECHANICAL DATA

NS (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

14-PINS SHOWN

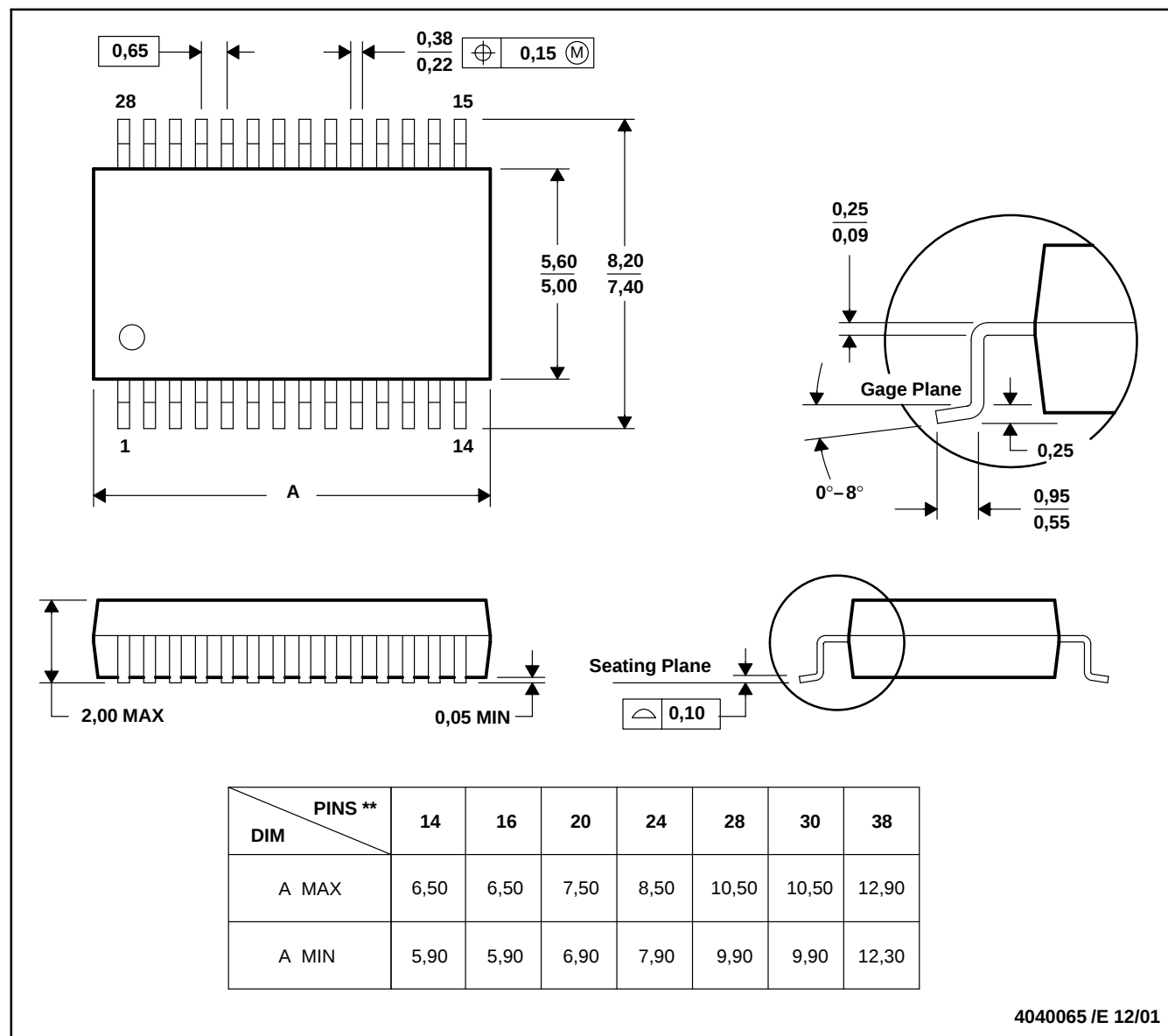


- NOTES:
- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

DB (R-PDSO-G**)

PLASTIC SMALL-OUTLINE

28 PINS SHOWN

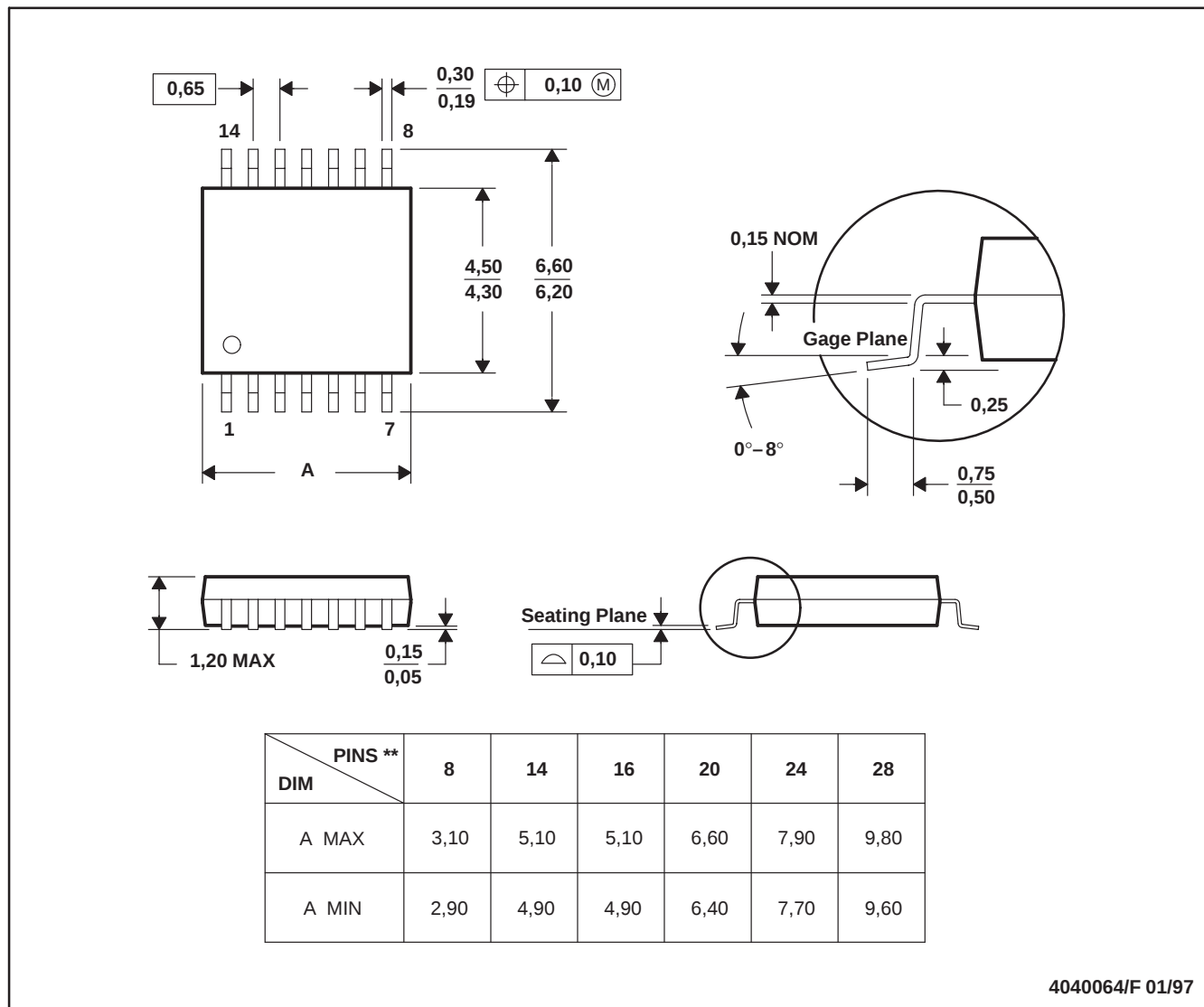


- NOTES: A. All linear dimensions are in millimeters.
 B. This drawing is subject to change without notice.
 C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
 D. Falls within JEDEC MO-150

PW (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

14 PINS SHOWN



- NOTES: A. All linear dimensions are in millimeters.
 B. This drawing is subject to change without notice.
 C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
 D. Falls within JEDEC MO-153

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